			230327006.1		PC	PCN Date:		March 30, 2023	
Title: Qualification of new				Fab site (CFAB) using qualified Process Technology, Die Revision,					
THU	Datasheet up	et update, additional Assembly Site (MLA) and BOM options for select device					ns for select devices		
Cus	stomer Contact:		PCN	<u>Manager</u>		De	pt:		Quality Services
Proposed 1 st Ship Date:					e requests ed until:			April 30, 2023	
*Sa	mple requests rece	ived	afte	r April 30, 2023 v	will not	be s	supp	orted.	
Cha	ange Type:								
\boxtimes	Assembly Site			Assembly Process			\boxtimes	Assembly Materials	
\boxtimes	Design		\square	Electrical Specifica	ation			Mechanical Specification	
	Test Site		\square	Packing/Shipping/	'Labeling]		Test Process	
Wafer Bump Site				Wafer Bump Mate	rial			Wafer Bump Process	
\boxtimes	Wafer Fab Site		\boxtimes	Wafer Fab Materia	ls		\boxtimes	Wafe	r Fab Process
			Part number change						
	DCN Detaile								

PCN Details

Description of Change:

Texas Instruments is pleased to announce the qualification of a new fab & process technology, (CFAB, JI3), die revision, and additional Assembly Site (MLA) and BOM options for selected devices listed below in the product affected section.

C	urrent Fab Sit	е	New Fab Site			
Current Fab Site	Process	Wafer Diameter	New Fab Site	Process	Wafer Diameter	
SFAB	JI1	150 mm	CFAB	JI3	200 mm	

The die was also changed as a result of the process change.

Assembly BOM options are noted below:

Group 1 Device:

	Cur	rent	Additional		
	ASESH FMX		FMX	MLA	
Wire type	0.96 mil Cu	0.96 mil Cu	0.8 mil Cu	0.8 mil Cu	
Lead finish	Matte Sn	NiPdAu	NiPdAu	NiPdAu	
Mold Compound	EN2000509	4211880	4211880	4211880	
Mount	EY1000063	4147858	4147858	4147858	
Compound	ET1000003	414/000	414/000	414/000	
Pin 1 marking	Stripe	Stripe	Dot/Dimple	Dot/Dimple	

Group 2 Device:

	Current	Additional
Wire diameter	0.96mil Cu	0.8mil Cu

The datasheet will be changing as a result of the above mentioned changes. The datasheet change details can be reviewed in the datasheet revision history. The link to the revised datasheet is available in the table below.



OP07, OP07C, OP07D SLOS099H – SEPTEMBER 1983 – REVISED MARCH 2023

4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

С	hanges from Revision G (November 2014) to Revision H (July 2022)	Page
•	Added supply condition to wide input voltage range feature bullet	1
•	Changed VCC+ to V+ and VCC- to V	3
•	Changed supply voltage abbreviation from VCC+ and VCC- to V _S in Absolute Maximum Ratings and throughout the data sheet	4
•	Changed note 5 in Absolute Maximum Ratings to include a note that fast-ramping shorts to the positive supply can damage the device	4
•	Changed Electrostatic discharge Human-body model and Charged-device model from 1000 V to ±1000	V 4
•	Added new values to Thermal Information	4
•	Changed Electrical Characteristics format	5
•	Changed parameter name from supply-voltage sensitivity to power supply rejection ratio in <i>Electrical</i> Characteristics	5
•	Changed parameter name from input offset voltage to Input voltage noise density in Electrical Character	ristics 5
•	Changed input current noise density unit from nV/vHz to pA/vHz in Electrical Characteristics	5
•	Changed parameter name from large-signal differential voltage gain to open-loop voltage gain in <i>Electri</i> Characteristics	
•	Changed parameter name from peak output voltage to voltage output swing in Electrical Characteristics	s <u>5</u>

Product Family	Current Datasheet Number	New Datasheet Number	Link to full datasheet
OP07C, OP07D, OP07	SLOS099G	SLOS099H	https://www.ti.com/product/OP07

Qual details are provided in the Qual Data Section.

Reason for Change:

These changes are part of our multiyear plan to transition products from our 150-milimeter factories to newer, more efficient manufacturing processes and technologies, underscoring our commitment to product longevity and supply continuity.

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

Impact on Environmental Ratings

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
🛛 No Change	🛛 No Change	🛛 No Change	🛛 No Change

Changes to product identification resulting from this PCN:

Fab Site Information:

Chip Site	Chip Site Origin Code (20L)	Chip Site Country Code (21L)	Chip Site City
SH-BIP-1	SHE	USA	Sherman
CFAB	CU3	CHN	Chengdu

Die Rev:	
Current	New
Die Rev [2P]	Die Rev [2P]
-	В

Assembly Site	Assembly Site Origin (22L)	Assembly Country Code (23L)	Assembly City	
ASESH	ASH	CHN	Shanghai	
TI Mexico	MEX	MEX	Aguascalientes	
TI Malaysia	MLA	MYS	Kuala Lumpur	

Sample product shipping label (not actual product label)



For alternate parts with similar or improved performance, please visit the product page on $\underline{\text{TI.com}}$

Qualification Report

Approve Date 03-May-2022

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>OP07CD</u>	QBS Process Reference: <u>LM2904BQDRQ1</u>	QBS Package Reference: <u>LM393BIDR</u>	QBS Package Reference: <u>TCAN1043DQ1</u> (<u>PG3.0)</u>	QBS Package Reference: <u>TCAN1043DQ1(PG1.0)</u>	QBS Package Reference: <u>TLV8542D</u>
HTOL	Auto High Temp Operating Life Grade 1, 150C	408 Hours	-	3/231/0	-	-	-	-
HTOL	Life Test, 140C	480 Hours	-	-	-	1/77/0	-	-
HTOL	Life Test, 150C	300 Hours	3/231/0	-	-	-	-	-
ELFR	Early Life Failure Rate, 125C	48 Hours	-	3/2400/4 (1)	-	-	-	-
нвм	ESD - HBM	1000 V	1/3/0	-	-	-	-	-
нвм	ESD - HBM	2000 V	-	3/9/0	-	-	-	-
CDM	ESD - CDM	1000 V	1/3/0	-	-	-	-	-
CDM	ESD - CDM	1500 V	-	3/9/0	-	-	-	-
LU	Latch-up	Per JESD78	1/6/0	3/18/0	-	1/6/0	-	1/6/0
ED	Electrical Characterization	Per Datasheet Parameters	1/30/0	3/90/0	-	3/90/0	-	-
тс	Temperature Cycle, - 65/150C	500 Cycles	-	3/231/0	1/77/0	1/77/0	2/154/0	1/77/0
UHAST	Unbiased HAST 130C/85%RH	96 Hours	-	3/231/0	1/77/0	-	-	-
AC	Autoclave 121C	96 Hours	-	-	-	1/77/0	2/154/0	1/77/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0	1/77/0	1/77/0	2/154/0	1/77/0

Туре	Test Name / Condition	Duration	Qual Device: <u>OP07CD</u>	QBS Process Reference: <u>LM2904BQDRQ1</u>	QBS Package Reference: <u>LM393BIDR</u>	QBS Package Reference: <u>TCAN1043DQ1</u> (PG3.0)	QBS Package Reference: <u>TCAN1043DQ1(PG1.0)</u>	QBS Package Reference: <u>TLV8542D</u>
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	1/77/0	-	-	-
HTSL	High Temp Storage Bake 175C	500 Hours	-	3/135/0	-	1/45/0	-	-
LI	Lead Pull to Destruction	Leads	-	-	-	1/42/0	-	-
PD	Physical Dimensions	Cpk>1.67	-	3/30/0	-	2/20/0	1/10/0	-
SD	Surface Mount Solderability	Pb	-	1/30/0	-	-	-	-
SD	Surface Mount Solderability	Pb Free Solder	-	-	-	-	1/15/0	-
SD	Surface Mount Solderability	Pb Solder	-	-	-	-	1/15/0	-

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles
Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free (SMT) and Green Note (1): ELFR fails due to a defect screenable at production test.

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Qualification Report Approve Date 02-September-2022

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>OP07CP</u>	QBS Process Reference: LM2904BQDRQ1	QBS Package Reference: <u>LM358BIDR</u>	QBS Product Reference: <u>OP07CD</u>
HAST	A2	Biased HAST	130C	96 Hours	-	3/231/0	3/231/0	-
UHAST	A3	Unbiased HAST	130C	96 Hours	1/77/0	3/231/0	3/231/0	-
TC	A4	Temperature Cycle	-65/150C	500 Cycles	1/77/0	3/231/0	3/231/0	-
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	3/135/0	3/231/0	-
HTOL	B1	Life Test	125C	1000 Hours	-	-	-	3/231/0
HTOL	B1	Life Test	150C	300 Hours	-	-	3/231/0	-
HTOL	B1	Life Test	150C	408 Hours	-	3/231/0	-	-
ELFR	B2	Early Life Failure Rate	125C	48 Hours	-	3/2400/4 ^{1,2}	-	-
PD	C4	Physical Dimensions	Cpk>1.67	-	-	3/30/0	-	-
ESD	E2	ESD CDM	-	1000 Volts	1/3/0	-	-	-
ESD	E2	ESD CDM	-	250 Volts	-	-	3/9/0	1/3/0
ESD	E2	ESD HBM	-	1000 Volts	-	-	3/9/0	1/3/0
ESD	E2	ESD HBM	-	2000 Volts	-	3/9/0	-	-
LU	E4	Latch-Up	Per JESD78	-	-	-	3/18/0	1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet	-	1/30/0	3/90/0	3/90/0	1/30/0
			Parameters					
FTY	E6	Final Test Yield	-	-	-	-	3/0/0	-

QBS: Qual By Similarity

Qual Device OP07CP is qualified at NOT CLASSIFIED NOT CLASSIFIED

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

• The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

• The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

Qualification Report

Approve Date 03-May-2022

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>OP07CD</u>	QBS Product Reference: <u>OP07CD</u>	QBS Process Reference: <u>LM2904BQDRQ1</u>	QBS Package Reference: <u>LM2903BQDRQ1</u>	QBS Package Reference: <u>TLV9032QDRQ1</u>
HTOL	Auto High Temp Operating Life Grade 1, 150C	408 Hours	-	-	3/231/0	-	-
HTOL	Life Test, 125C	1000 Hours	-	-	-	-	3/231/0
HTOL	Life Test, 150C	300 Hours	-	3/231/0	-	-	1/77/0
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	3/2400/4 (1)	-	-
HBM	ESD - HBM	1000 V	-	1/3/0	-	-	-
нвм	ESD - HBM	2000 V	-	-	3/9/0	-	-
CDM	ESD - CDM	1000 V	-	1/3/0	-	-	-
CDM	ESD - CDM	1500 V	-	-	3/9/0	-	-
LU	Latch-up	Per JESD78	-	1/6/0	3/18/0	-	-
ED	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	3/90/0	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	3/231/0	-	3/231/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	-	3/231/0
HTSL	High Temp Storage Bake 175C	500 Hours	-	-	3/135/0	-	-
тс	Temperature Cycle, -65/150C	500 Cycles	-	-	3/231/0	-	3/231/0
UHAST	Unbiased HAST 130C/85%RH	96 Hours	-	-	3/231/0	-	3/231/0
SD	Free Surface Mount Solderability	Pb Free	-	-	1/30/0	1/15/0	-

Туре	Test Name / Condition	Duration	Qual Device: <u>OP07CD</u>	QBS Product Reference: <u>OP07CD</u>	QBS Process Reference: <u>LM2904BQDRQ1</u>	QBS Package Reference: <u>LM2903BQDRQ1</u>	QBS Package Reference: <u>TLV9032QDRQ1</u>
PD	Auto Physical Dimensions	Cpk>1.67	-	-	3/30/0	-	-
SD	Surface Mount Solderability	Pb	-	-	1/30/0	-	-
YLD	FTY and Bin Summary	-	1/Pass	-	-	-	-

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD[47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status: Qualified Pb-Free (SMT) and Green

Note (1): ELFR fails due to a defect screenable at production test.

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail			
WW Change Management Team	PCN ww admin team@list.ti.com			

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